

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT6528971

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUEH-MING TUNG	01/26/2021
CHIA-MING YANG	01/26/2021
JUNG-WEI CHEN	01/26/2021
JIAN-DE LEU	01/26/2021
GUAN-LIN PAN	01/26/2021
RECEIVING PARTY DATA	
Name:	ORIENT SEMICONDUCTOR ELECTRONICS, LIMITED
Street Address:	NO. 9, CENTRAL 3RD ST.
Internal Address:	NANTZE EXPORT PROCESSING ZONE
City:	KAOHSIUNG
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17165125
CORRESPONDENCE DATA	
Fax Number:	(410)461-3067
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	4104656678
Email:	rkl@rkpatlaw.com
Correspondent Name:	ROSENBERG, KLEIN & LEE
Address Line 1:	3458 ELLICOTT CENTER DRIVE, SUITE 101
Address Line 4:	ELLICOTT CITY, MARYLAND 21043
ATTORNEY DOCKET NUMBER:	MR4391-128
NAME OF SUBMITTER:	MORTON J. ROSENBERG
SIGNATURE:	/Morton J. Rosenberg/
DATE SIGNED:	02/02/2021
Total Attachments: 3	
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ASSIGNMENT DEED

Attorney docket No. MR4391-128

This Assignment agreement is applicable to an invention entitled (Invention Title):

MANUFACTURING METHOD OF SEMICONDUCTOR PACKAGE

The PATENT RIGHTS referred to in this agreement are:

(Check one)

- ☐ a Patent Application for this invention, executed by the ASSIGNOR(S) concurrently with this Assignment
- ☒ U.S. Patent Application Serial No. 17/165,125, filed 2/2/2021
- ☐ U.S. Patent No. _____, issued _____

The PATENT RIGHTS assigned under this agreement are:

(Check One)

☒ U.S. Patent rights only

☐ worldwide Patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. Patent Application identified above.

I/WE believe that I/WE am/are the original inventor(s) of a claimed invention in the application.

The above-identified Application was made or authorized by me/us.

I/WE hereby acknowledge that any will false statements made in this Assignment is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

The ASSIGNOR(S) referred to in this agreement is (or are):

(Full name of sole or first assignor) YUEH-MING TUNG(Address) No. 9, Central 3rd St., Nantze Export Processing Zone, Kaohsiung, Taiwan, R.O.C.(Full name of second joint assignor, if any) CHIA-MING YANG(Address) No. 9, Central 3rd St., Nantze Export Processing Zone, Kaohsiung, Taiwan, R.O.C.(Full name of third joint assignor, if any) JUNG-WEI CHEN(Address) No. 9, Central 3rd St., Nantze Export Processing Zone, Kaohsiung, Taiwan, R.O.C.(Full name of fourth joint assignor, if any) JIAN-DE LEU(Address) No. 9, Central 3rd St., Nantze Export Processing Zone, Kaohsiung, Taiwan, R.O.C.(Full name of fourth joint assignor, if any) GUAN-LIN PAN(Address) No. 9, Central 3rd St., Nantze Export Processing Zone, Kaohsiung, Taiwan, R.O.C.☐ Additional assignors are being named on separately numbered sheets attached hereto.

The sole or first ASSIGNEE(S) referred to in this agreement is (or are):

(Name of Assignee) Orient Semiconductor Electronics, Limited(Address of Assignee) No. 9, Central 3rd St., Nantze Export Processing Zone, Kaohsiung, Taiwan, R.O.C.

The sole or first ASSIGNEE is: (Check One)

- ☐ an individual
☐ a partnership
☒ a Corporation of Taiwan R.O.C. (State or Country)

The second ASSIGNEE(S) (if any) referred to in this agreement is (or are):

(Name of Assignee)

Assignee) _____ (Address of

The second ASSIGNEE is: (Check One)

- ☐ an individual
☐ a partnership
☐ a Corporation of _____ (State or Country)

The third ASSIGNEE(S) (if any) referred to in this agreement is (or are):

(Name of Assignee)

Assignee) _____ (Address of

The third ASSIGNEE is: (Check One)

- ☐ an individual
☐ a partnership
☐ a Corporation of _____ (State or Country)

☐ Additional assignees are being named on separately numbered sheets attached hereto.

The ASSIGNOR(S), in consideration of \$1.00 paid by each ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, have and do hereby assign the following to each ASSIGNEE; their successors and assigns:

the full and exclusive right to the invention;

an equal interest in and to the entire right, title, and interest in and to the PATENT RIGHTS in the invention, and all continuation, continuation-in-part, divisional, re-issue, and re-examination patents and patent applications relating to the PATENT RIGHTS; and

the right to claim priority under 35 U.S.C. § 119, based on any earlier foreign applications for this invention.

As to all U.S. Patent Applications assigned under this Agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Director of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE(S) as the ASSIGNEE(S) of an equal interest in the entire right, title, and interest, for the sole use and enjoyment of said ASSIGNEE(S), their successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE(S), or their representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination, and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE(S), make all rightful oaths, and generally do

everything necessary or desirable to aid said ASSIGNEE(S), their successors and assigns, to obtain and enforce proper protection for said invention.

WE hereby give our Attorney authorization to insert the Serial Number and filing date of the above-referenced Patent Application when known.

YUEH-MING TUNG

(Signature of sole or first assignor)

Yueh - Ming Tung

January 26, 2021
(Date)

CHIA-MING YANG

(Signature of second assignor, if any)

Chia - Ming Yang

January 26, 2021
(Date)

JUNG-WEI CHEN

(Signature of third assignor, if any)

Jung - Wei Chen

January 26, 2021
(Date)

JIAN-DE LEU

(Signature of fourth assignor, if any)

Jian - De Leu

January 26, 2021
(Date)

GUAN-LIN PAN

(Signature of fifth assignor, if any)

Guan - Lin Pan

January 26, 2021
(Date)